



BCP53H-Q series

80 V, 1 A PNP medium power transistors

Rev. 1 — 29 March 2023

Product data sheet

1. General description

PNP medium power transistors in a SOT223 (SC-73) Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- High collector current capability I_C and I_{CM}
- Three current gain selections
- High power dissipation capability
- High-temperature applications up to 175 °C
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- Linear voltage regulators
- MOSFET drivers
- High-side switches
- Power management
- Amplifiers

4. Quick reference data

Table 1. Quick reference data

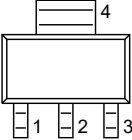
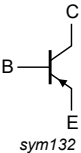
$T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{CEO}	collector-emitter voltage	open base		-	-	-80	V
I_C	collector current			-	-	-1	A
I_{CM}	peak collector current	single pulse; $t_p \leq 1\text{ ms}$		-	-	-2	A
h_{FE}	DC current gain						
	BCP53H-Q	$V_{CE} = -2\text{ V}; I_C = 150\text{ mA}$	[1]	63	-	250	
	BCP53-10H-Q		[1]	63	-	160	
	BCP53-16H-Q		[1]	100	-	250	

[1] pulsed; $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$

5. Pinning information

Table 2. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base		
2	C	collector		
3	E	emitter		
4	C	collector		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BCP53H-Q	SC-73	plastic, surface-mounted package with increased heatsink; 4 leads	SOT223
BCP53-10H-Q			
BCP53-16H-Q			

7. Marking

Table 4. Marking

Type number	Marking code
BCP53H-Q	BCP53H
BCP53-10H-Q	P5310H
BCP53-16H-Q	P5316H

8. Limiting values

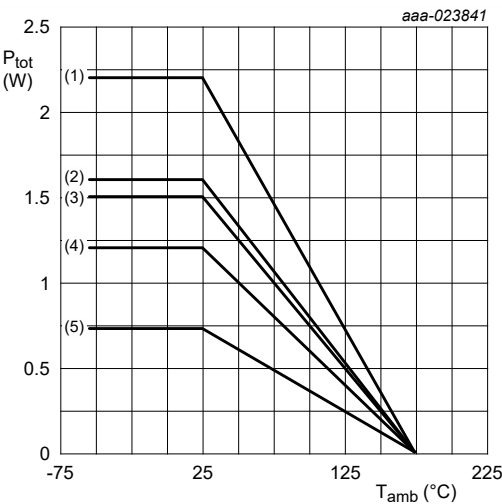
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

$T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified.

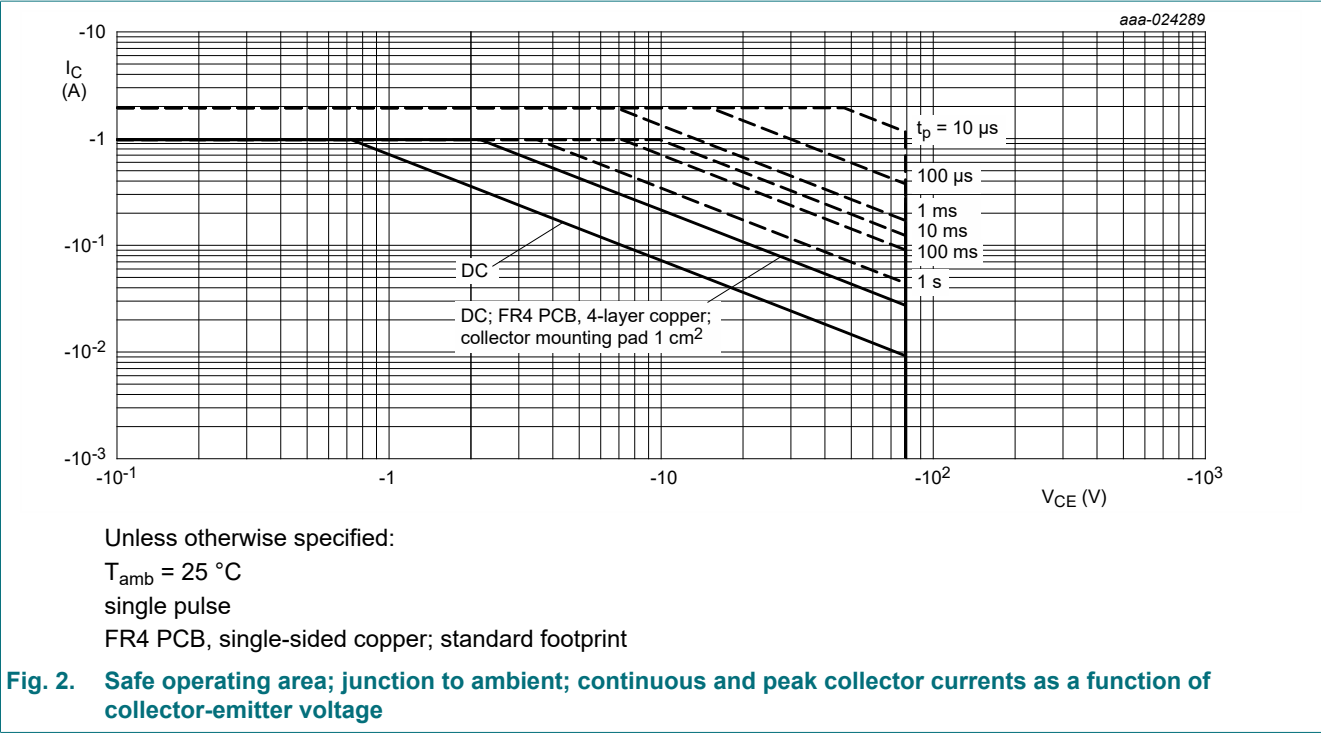
Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	-100	V
V_{CEO}	collector-emitter voltage	open base	-	-80	V
V_{EBO}	emitter-base voltage	open collector	-	-7	V
I_C	collector current		-	-1	A
I_{CM}	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	-2	A
I_B	base current		-	-0.2	A
I_{BM}	peak base current	single pulse; $t_p \leq 1\text{ ms}$	-	-0.3	A
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ }^{\circ}\text{C}$	[1]	-	725 mW
			[2]	-	1.2 W
			[3]	-	1.5 W
			[4]	-	1.6 W
			[5]	-	2.2 W
T_j	junction temperature		-	175	$^{\circ}\text{C}$
T_{amb}	ambient temperature		-55	175	$^{\circ}\text{C}$
T_{stg}	storage temperature		-65	175	$^{\circ}\text{C}$

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 1 cm².
- [3] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 6 cm².
- [4] Device mounted on an FR4 PCB, 4-layer copper; tin-plated and standard footprint..
- [5] Device mounted on an FR4 PCB, 4-layer copper; tin-plated; mounting pad for collector 1 cm².



- (1) FR4 PCB, 4-layer copper, 1 cm²
- (2) FR4 PCB, 4-layer copper, standard footprint
- (3) FR4 PCB, single-sided copper, 6 cm²
- (4) FR4 PCB, single-sided copper, 1 cm²
- (5) FR4 PCB, single-sided copper, standard footprint

Fig. 1. Power derating curves SOT223



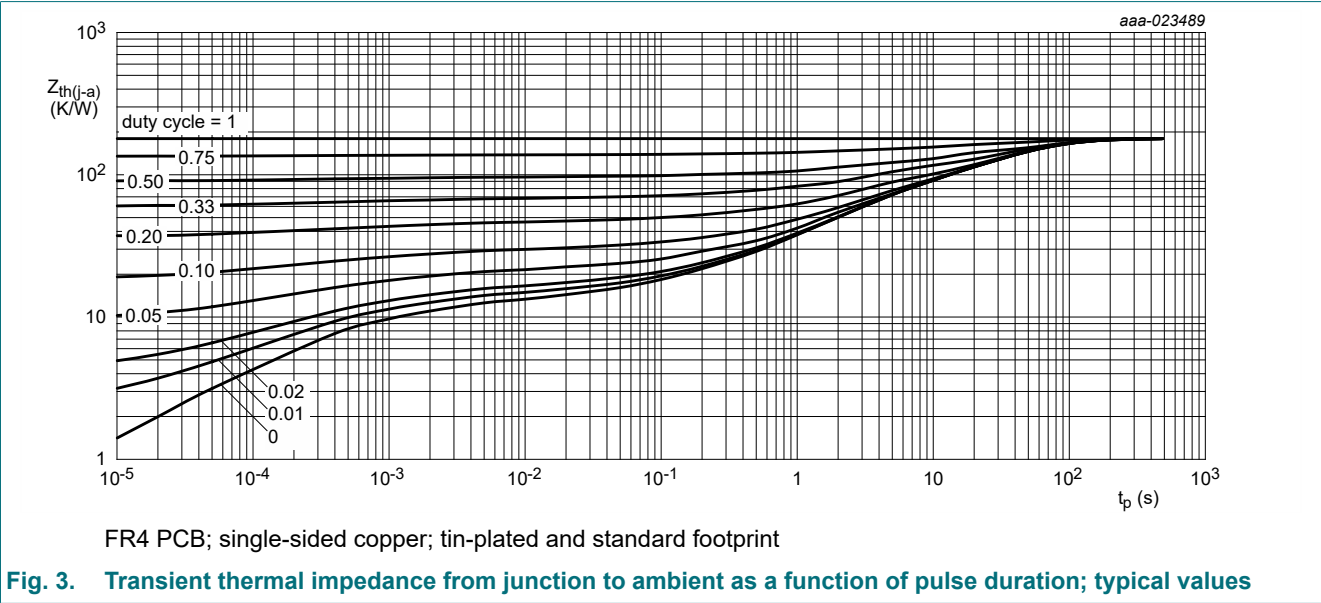
9. Thermal characteristics

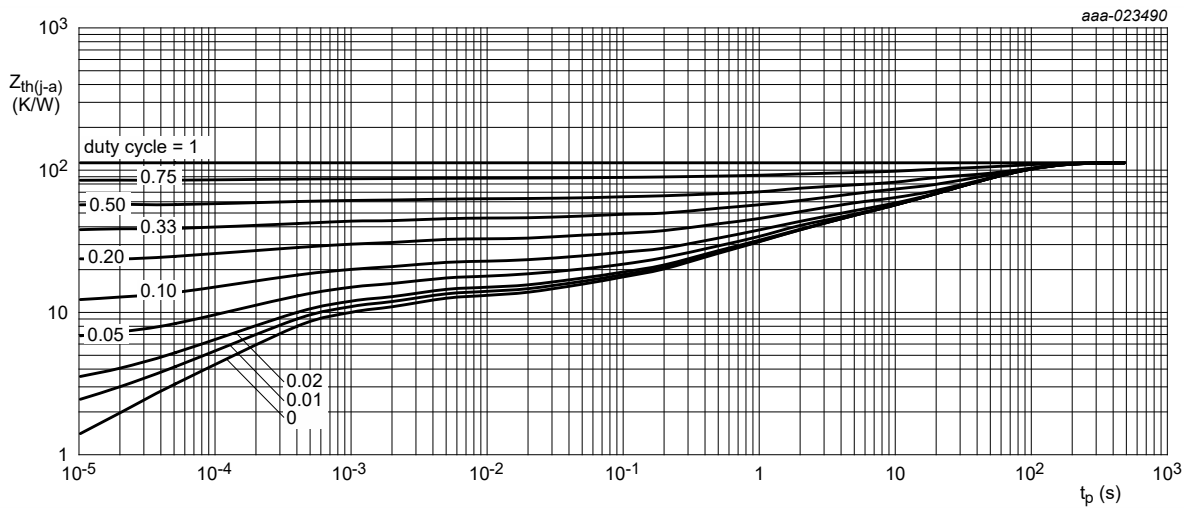
Table 6. Thermal characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	207	K/W
			[2]	-	-	125	K/W
			[3]	-	-	100	K/W
			[4]	-	-	94	K/W
			[5]	-	-	69	K/W
$R_{(j-sp)}$	thermal resistance from junction to solder point			-	-	18	K/W

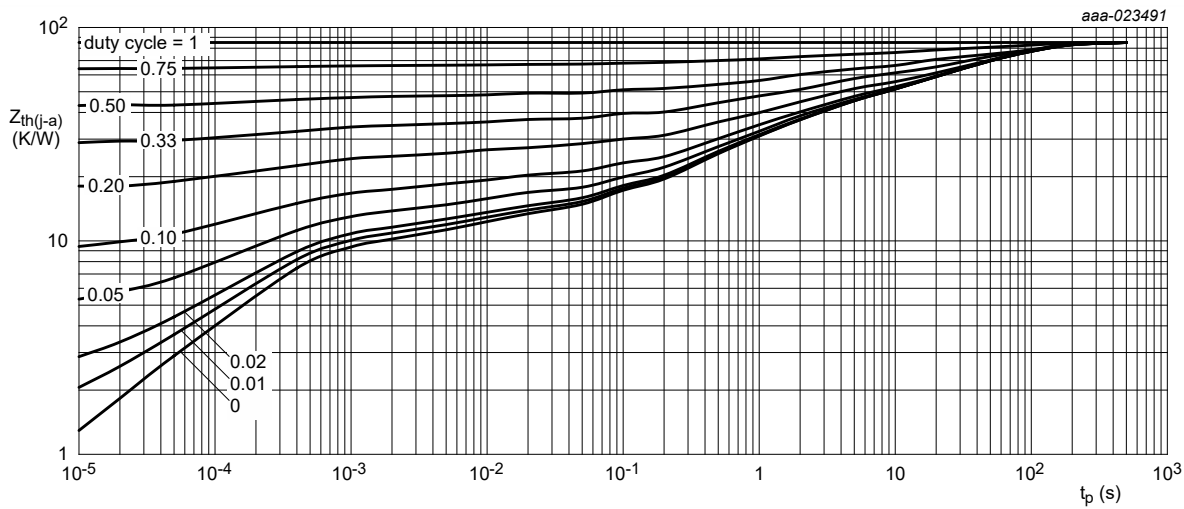
- [1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm².
[3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm².
[4] Device mounted on an FR4 PCB, 4-layer copper; tin-plated and standard footprint.
[5] Device mounted on an FR4 PCB, 4-layer copper; tin-plated; mounting pad for collector 1 cm².





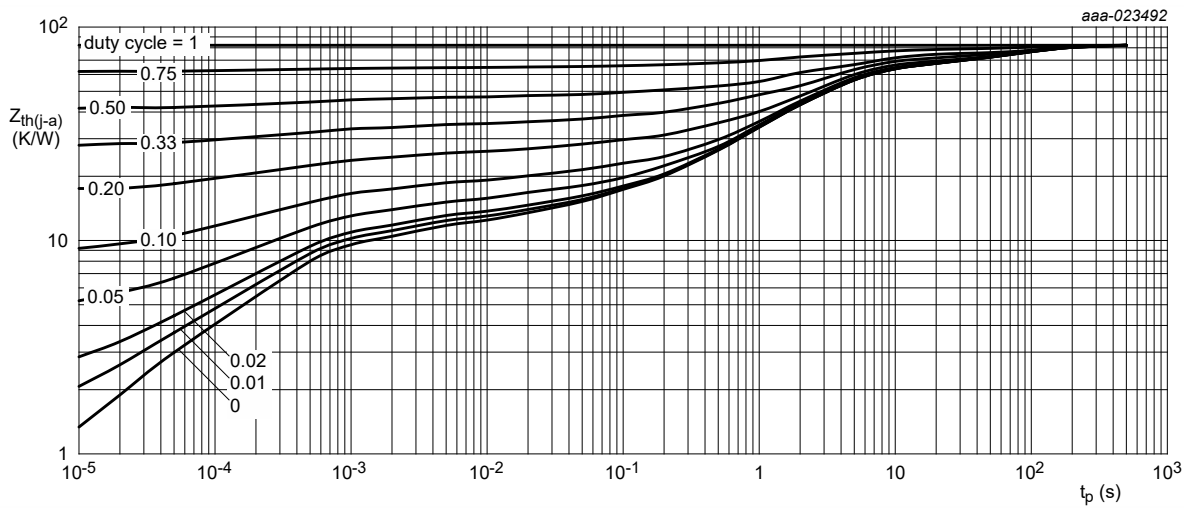
FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm²

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



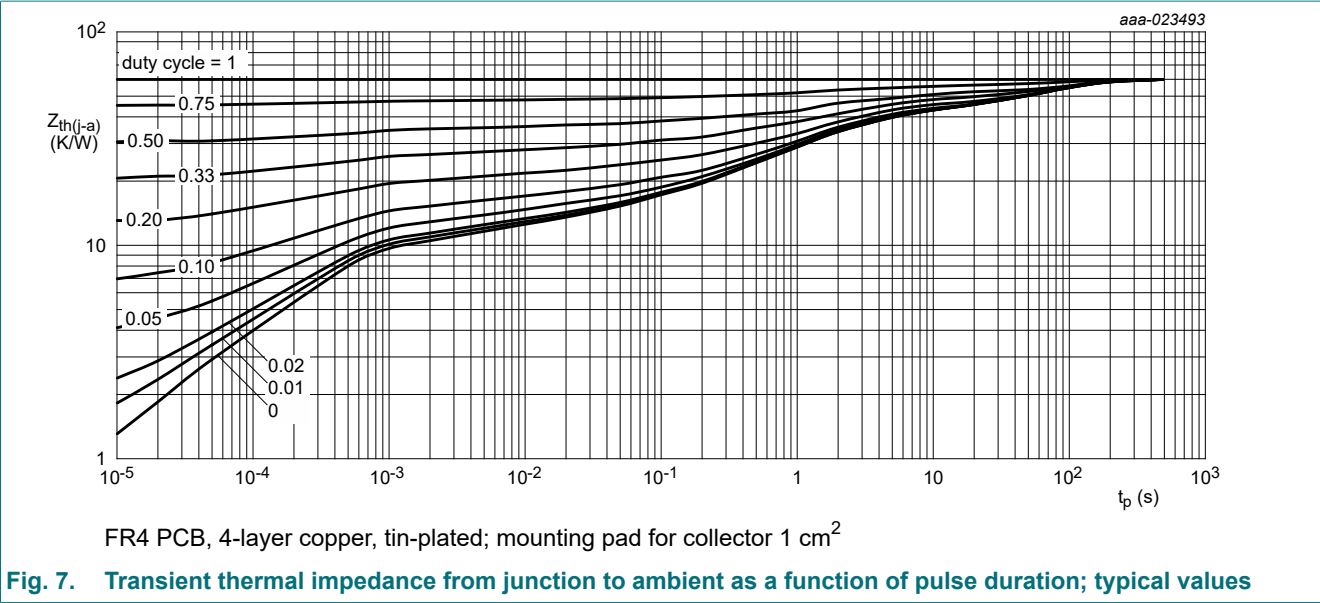
FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm²

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, 4-layer copper, tin-plated and standard footprint.

Fig. 6. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



10. Characteristics

Table 7. Characteristics
T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I _{CBO}	collector-base cut-off current	V _{CB} = -30 V; I _E = 0 A		-	-	-100	nA
		V _{CB} = -30 V; I _E = 0 A; T _j = 150 °C		-	-	-10	μA
I _{EBO}	emitter-base cut-off current	V _{EB} = -5 V; I _C = 0 A		-	-	-100	nA
h _{FE}	DC current gain						
	BCP53H-Q	V _{CE} = -2 V; I _C = -5 mA	[1]	63	-	-	
		V _{CE} = -2 V; I _C = -150 mA		63	-	250	
		V _{CE} = -2 V; I _C = -500 mA		40	-	-	
	BCP53-10H-Q	V _{CE} = -2 V; I _C = -5 mA	[1]	63	-	-	
		V _{CE} = -2 V; I _C = -150 mA		63	-	160	
		V _{CE} = -2 V; I _C = -500 mA		40	-	-	
	BCP53-16H-Q	V _{CE} = -2 V; I _C = -5 mA	[1]	63	-	-	
		V _{CE} = -2 V; I _C = -150 mA		100	-	250	
		V _{CE} = -2 V; I _C = -500 mA		40	-	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = -500 mA; I _B = -50 mA	[1]	-	-	-500	mV
V _{BE}	base-emitter voltage	V _{CE} = -2 V; I _C = -500 mA	[1]	-	-	-1	V
f _T	transition frequency	V _{CE} = -5 V; I _C = -50 mA; f = 100 MHz		100	140	-	MHz
C _c	collector capacitance	V _{CB} = -10 V; I _E = I _E = 0 A; f = 1 MHz		-	7	-	pF

[1] pulsed; t_p ≤ 300 μs; δ ≤ 0.02

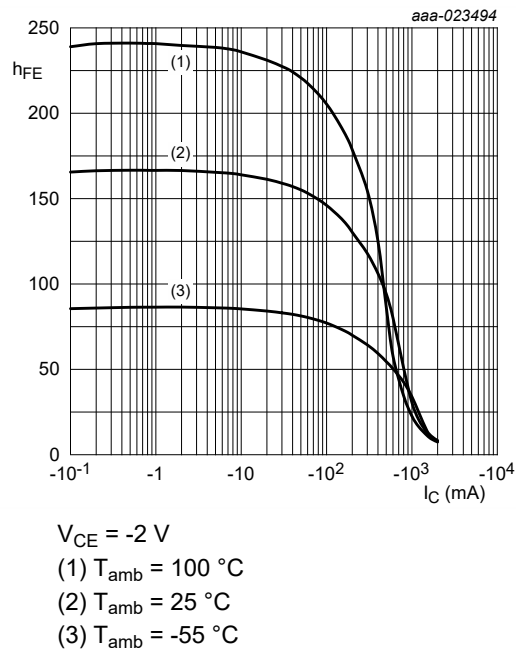


Fig. 8. DC current gain as a function of collector current; typical values

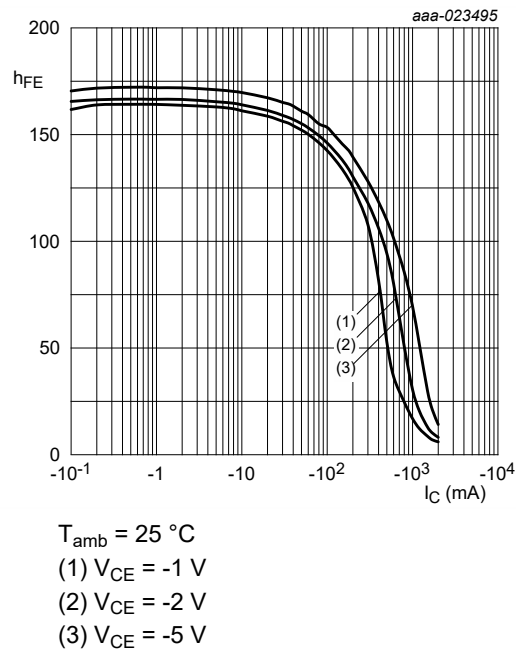


Fig. 9. DC current gain as a function of collector current; typical values

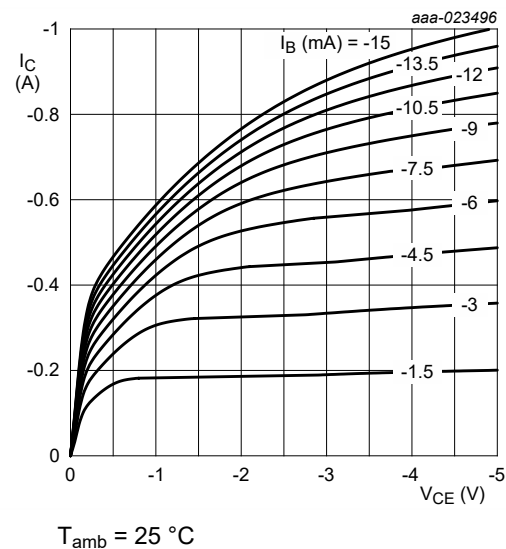


Fig. 10. Collector current as a function of collector-emitter voltage; typical values

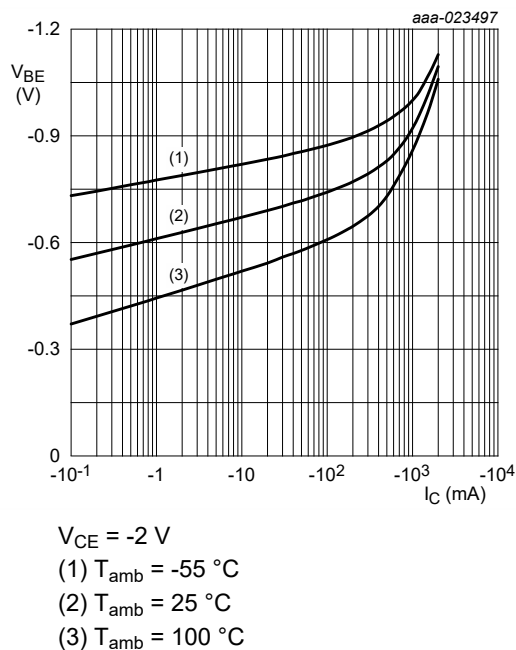


Fig. 11. Base-emitter voltage as a function of collector current; typical values

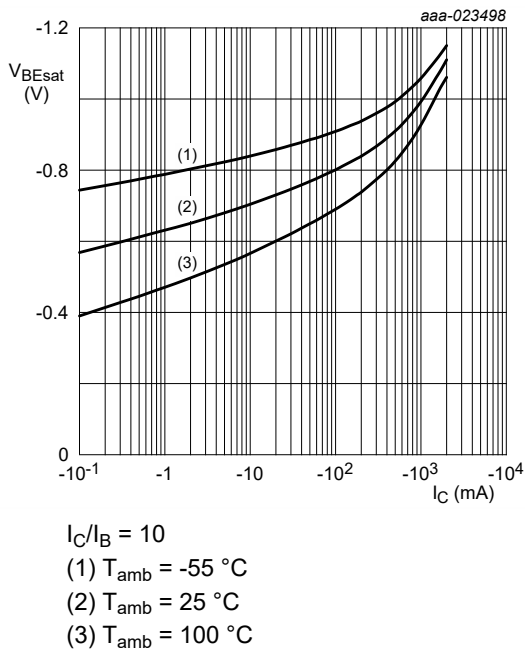


Fig. 12. Base-emitter saturation voltage as a function of collector current; typical values

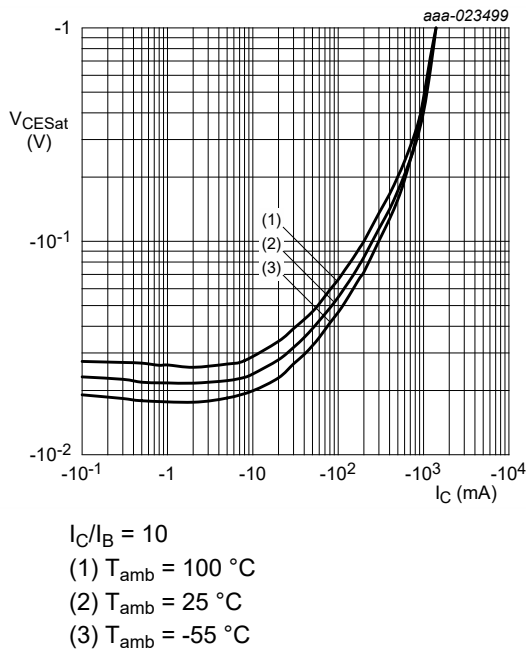


Fig. 13. Collector-emitter saturation voltage as a function of collector current; typical values

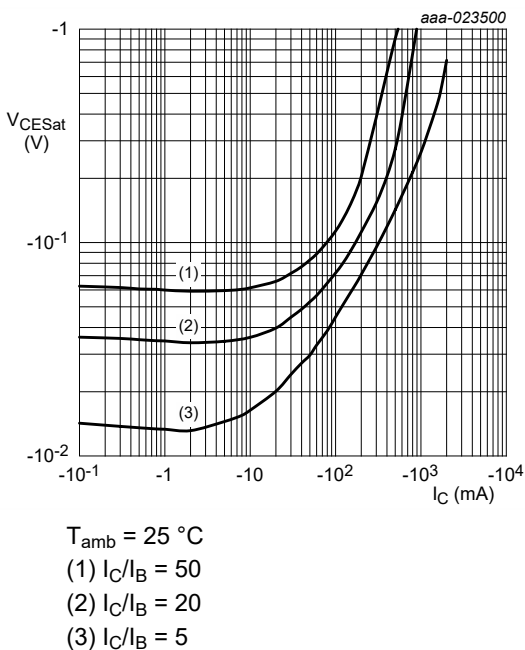


Fig. 14. Collector-emitter saturation voltage as a function of collector current; typical values

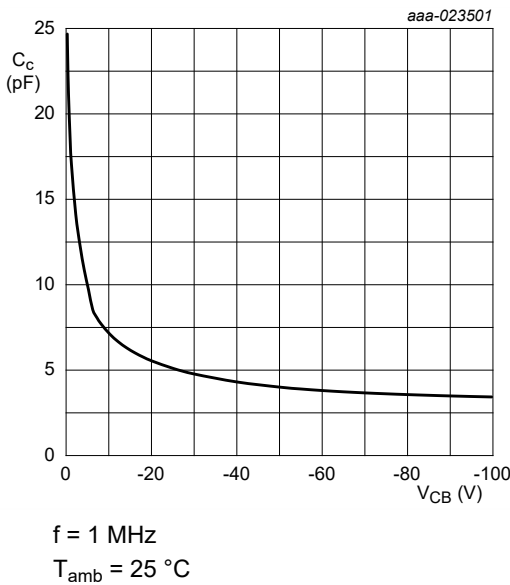


Fig. 15. Collector capacitance as a function of collector-base voltage; typical values

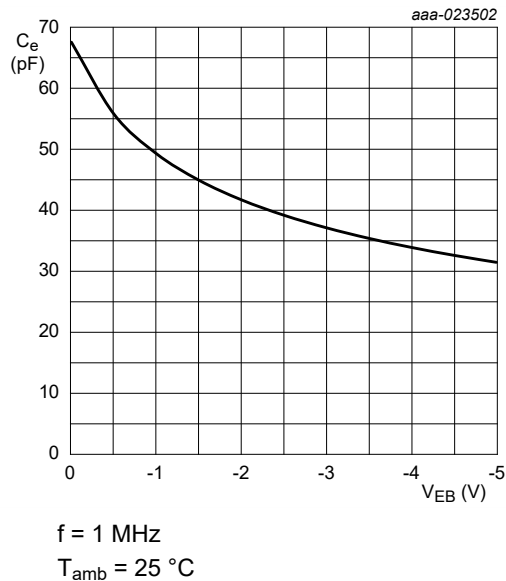


Fig. 16. Emitter capacitance as a function of emitter-base voltage; typical values

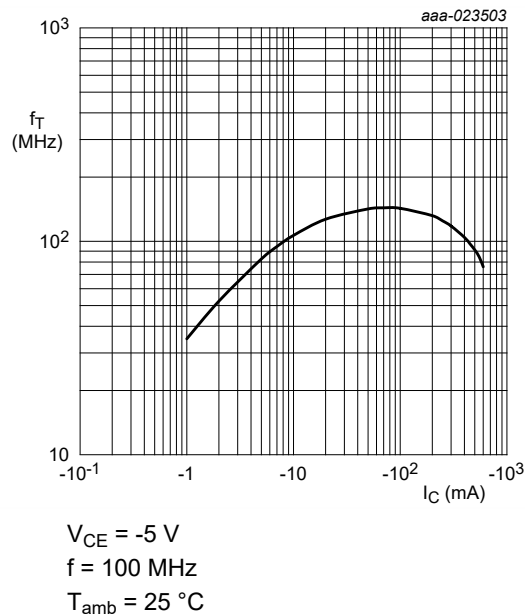


Fig. 17. Transition frequency as a function of collector current; typical values

11. Test information

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

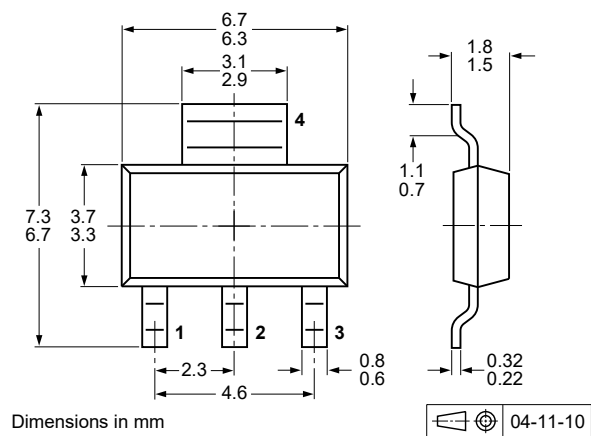
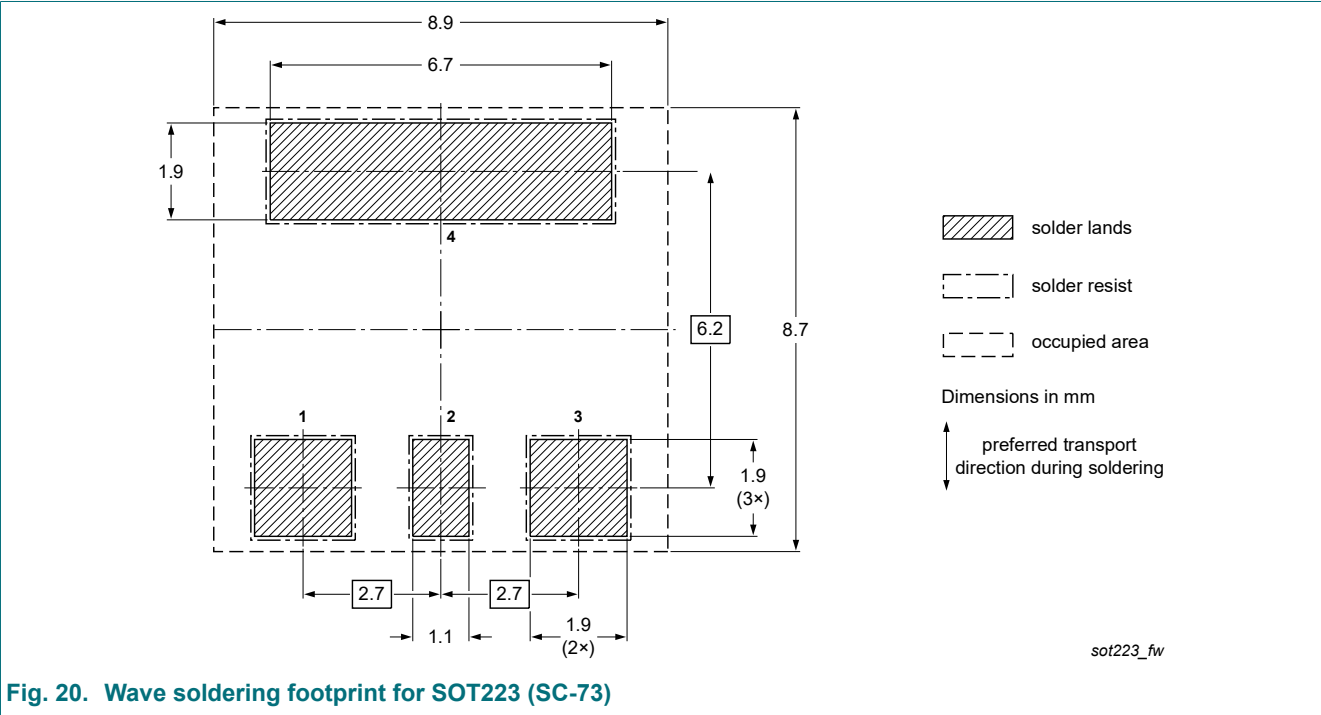
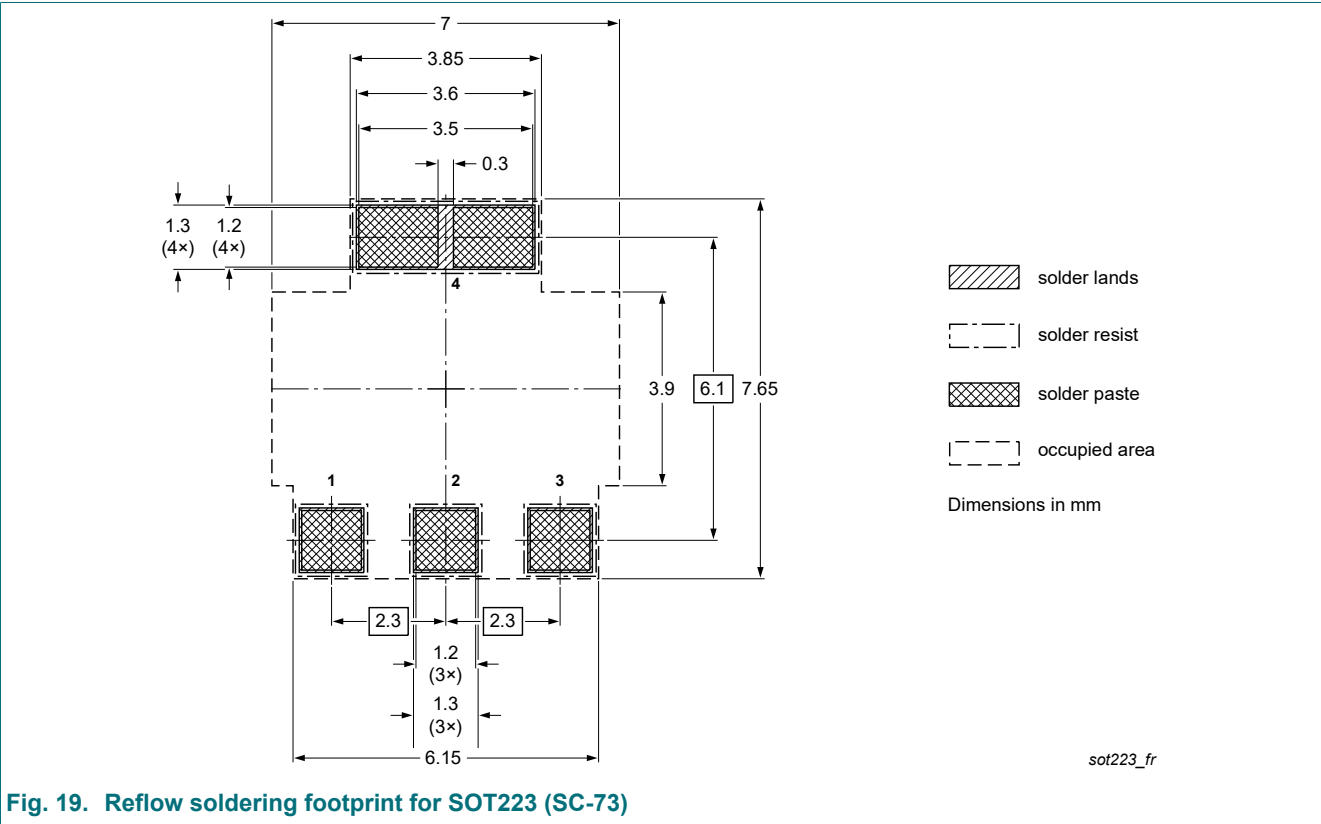


Fig. 18. Package outline SOT223 (SC-73)

13. Soldering



14. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BCP53H-Q_SER v.1	20230329	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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